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Part Number: **XLBGE08W**

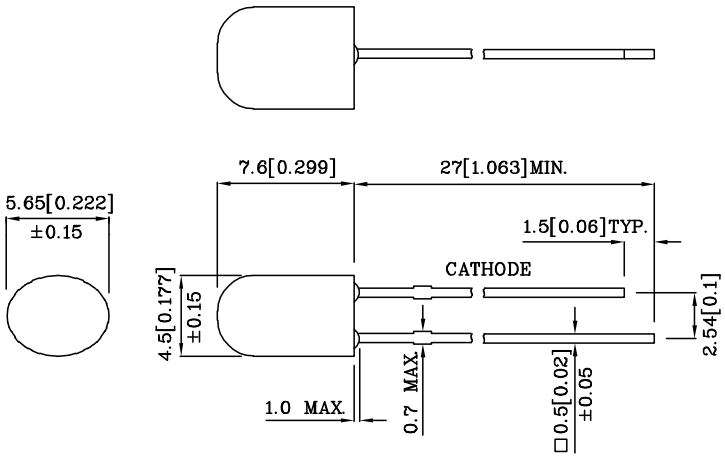
OVAL LED LAMP

PRELIMINARY SPEC

Features

- ULTRA BRIGHTNESS.
- OUTSTANDING MATERIAL EFFICIENCY.
- RELIABLE AND RUGGED.
- IC COMPATIBLE/LOW CURRENT CAPABILITY.
- RoHS COMPLIANT.

ATTENTION
OBSERVE PRECAUTIONS
FOR HANDLING
ELECTROSTATIC
DISCHARGE
SENSITIVE
DEVICES



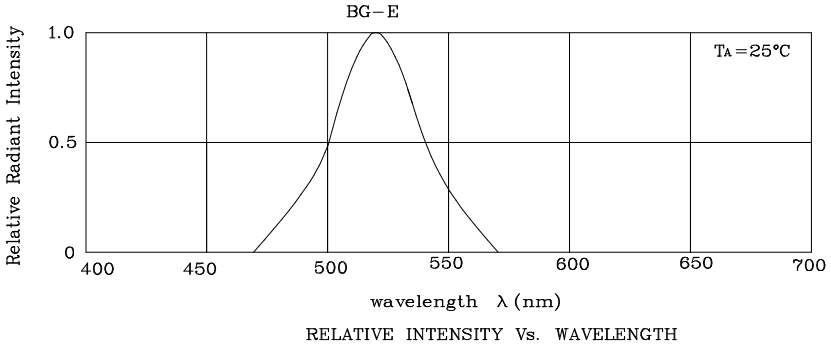
Notes:

1. All dimensions are in millimeters (inches).
2. Tolerance is ± 0.25(0.01") unless otherwise noted.

Absolute Maximum Ratings (T_A=25°C)		**BG-E (InGaN)**	**Unit**
Reverse Voltage	V_R	5	V
Forward Current	I_F	30	mA
Forward Current (Peak) 1/10 Duty Cycle 0.1ms Pulse Width	i_{FS}	150	mA
Power Dissipation	P_T	120	mW
Operating Temperature	T_A	-40 ~ +85	°C
Storage Temperature	Tstg	-40 ~ +85	
Electrostatic Discharge Threshold (HBM)	1000		V
Lead Solder Temperature [2mm Below Package Base]	260°C For 3 Seconds		
Lead Solder Temperature [5mm Below Package Base]	260°C For 5 Seconds		

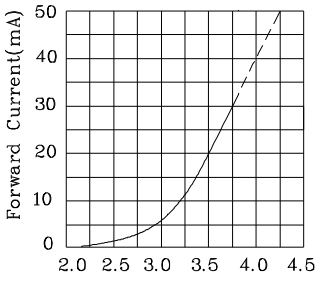
Operating Characteristics (T_A=25°C)		**BG-E (InGaN)**	**Unit**
Forward Voltage (Typ.) (I_F=20mA)	V_F	3.5	V
Forward Voltage (Max.) (I_F=20mA)	V_F	4.5	V
Reverse Current (V_R=5V)	I_R	10	uA
Wavelength of Peak Emission (I_F=20mA)	λ P	518	nm
Wavelength of Dominant Emission (I_F=20mA)	λ D	525	nm
Spectral Line Full Width At Half-Maximum (I_F=20mA)	Δλ	36	nm
Capacitance (V_F=0V, f=1MHz)	C	50	pF

Part Number	Emitting Color	Emitting Material	Lens-color	Luminous Intensity (IF=20mA) mcd		Wavelength nm λ P	Viewing Angle 2 θ 1/2
				min.	typ.		
XLBGE08W	Green	InGaN	Water Clear	480	995	518	30°(H) 60°(V)

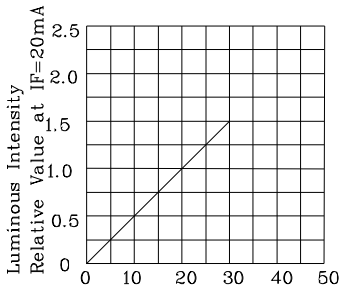


RELATIVE INTENSITY Vs. WAVELENGTH

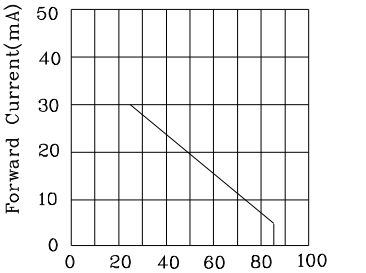
❖ **BG-E**



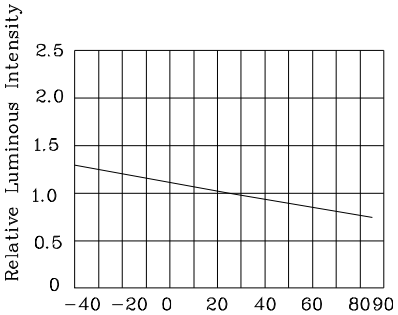
FORWARD CURRENT Vs.
FORWARD VOLTAGE



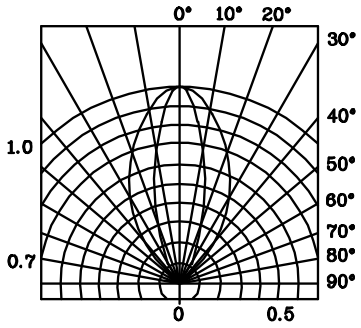
LUMINOUS INTENSITY Vs.
FORWARD CURRENT



FORWARD CURRENT
DERATING CURVE

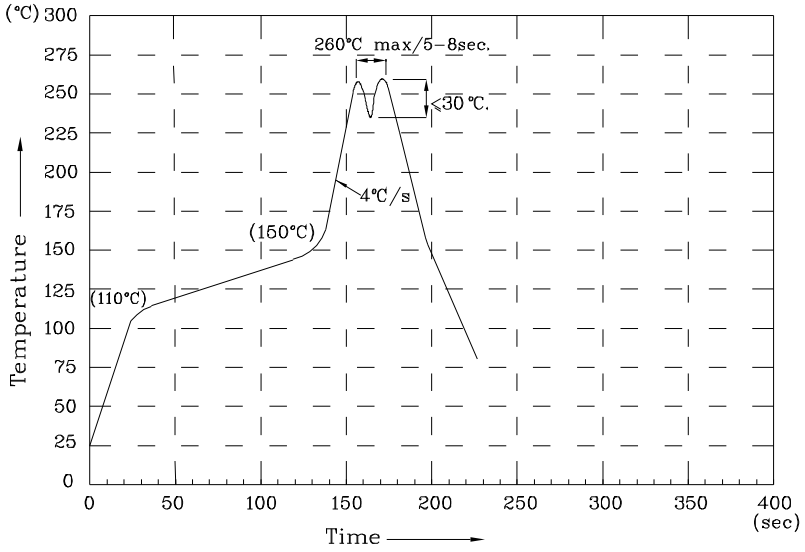


LUMINOUS INTENSITY Vs.
AMBIENT TEMPERATURE



SPATIAL DISTRIBUTION

Wave Soldering Profile For Lead-free Through-hole LED.



NOTES:

1. Recommend the wave temperature 245℃~260℃. The maximum soldering temperature should be less than 260℃.
2. Do not apply stress on epoxy resins when temperature is over 85 degree℃.
3. The soldering profile apply to the lead free soldering (Sn/Cu/Ag alloy).
4. No more than once.

Remarks:

If special sorting is required (e.g. binning based on forward voltage, luminous intensity, or wavelength), the typical accuracy of the sorting process is as follows:

1. Wavelength: +/-1nm
2. Luminous Intensity: +/-15%
3. Forward Voltage: +/-0.1V

Note: Accuracy may depend on the sorting parameters.